

STG3689

Low Voltage 0.9Ω max dual SPDT Switch with break-before-make feature

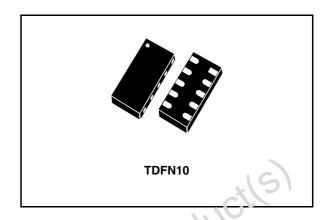
Features

- Low quiescent supply current:
 - Max \pm 50μA for V_{1IN}, V_{2IN} = 1.80V at V_{CC} = 4.3V
- Ultra low power dissipation:
 - $I_{CC} = 0.2 \mu A \text{ (Max.) at } T_A = 85 ^{\circ}\text{C}, V_{IN} = 0 \text{V}$
- Switch S1: Low "ON" resistance V_{IN} = 0V:
 - R_{ON} = 0.7Ω (Max. T_A =25°C) at V_{CC} = 4.3V
 - R_{ON} = 0.9Ω (Max. T_A = 25° C) at V_{CC} = 3V
- Wide operating voltage range:
 - V_{CC} (OPR) = 1.65V to 4.3V single supply
- 4.3V Tolerant and 1.8V compatible threshold on digital control input at V_{CC} = 1.65 to 4.3V
- Latch-up performance exceed 300mA (JESD 17)
- ESD performance (Analog chan. Vs. GND): HBM >2kV (MIL STD 883 method 3015)

Description

The STG3689 is a high-speed CMOS low voltage dual analog S.P.D.T. (Single Pole Dual Throw) switch or 2:1 Multiplexer/Demultiple xer switch fabricated in silicon gate C²MOS technology. It is designed to operate from 1.35V to 4.3V, making this device ideal for portable applications.

The nIN inputs are provided to control the switches.



The switches riG1 are ON (they are connected to common Ports Dn) when the nIN' input is held high and OFF (high impedance state exists between the two ports) when nIN is held low. The switches nS2 are ON (they are connected to common Ports Dn) when the nIN input is held low and OFF (high impedance state exists between the two ports) when IN is held high.

Additional key features are fast switching speed, and ultra low power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Order codes

Part number	Package	Packaging
STG3689DTR	TDFN10 (2.5mm x 1.3mm)	Tape & Reel

Contents STG3689

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1 Summary description

1.1 Pin connections and description

Figure 1. Pin connections (Top through view)

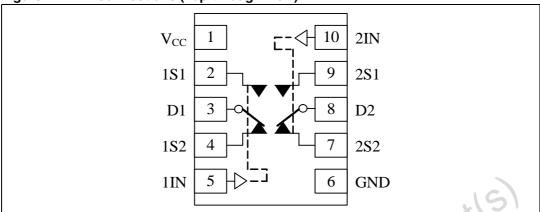
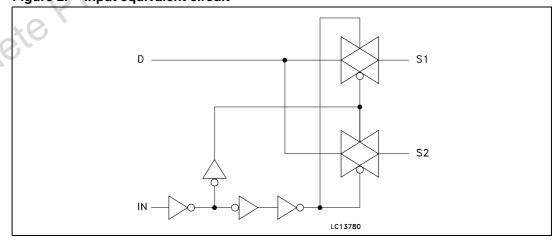


Table 1. Pin function

Pin №	Symbol	Name and function
5, 10	1IN, 2IN	Controls
2, 4, 9, 7	1\$1, 1\$2 2\$1, 2\$2	Independent channels
3, 8	D1, D2	Common channels
1	V _{CC}	Positive supply voltage
6	GND	Ground (0V)

1.2 Input equivalent circuit

Figure 2. Input equivalent circuit



Electrical ratings STG3689

2 Electrical ratings

Stressing the device above the rating listed in the "Absolute Maximum Ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to 5.5	V
VI	DC input voltage	-0.5 to V _{CC} + 0.5	V
V _{IC}	DC control input voltage	-0.5 to 5.5	V
V _O	DC output voltage	-0.5 to V _{CC} + 0.5	٧
I _{IKC}	DC input diode current on control pin (V _{IN} < 0V)	-50	mA
I _{IK}	DC input diode current (V _{IN} < 0V)	±50	mA
I _{OK}	DC output diode current	±20	mA
Io	DC output current	±200	mA
I _{OP}	DC output current peak (pulse at 1ms, 10% duty cycle)	±400	mA
I _{CC} or I _{GND}	DC V _{CC} or ground current	±100	mA
P _D	Power dissipation at T _A = 70°C (1)	1120	mW
T _{stg}	Storage temperature	-65 to 150	°C
T _L	Lead temperature (10 sec.)	300	°C

^{1.} Derate above 70°C by 18.5mW/C

Electrical characteristics 3

3.1 **Recommended operating conditions**

Recommended operating conditions Table 3.

Symbol		Parame		Value	Unit			
V _{CC}	Supply volta	ge ⁽¹⁾			1.4 to 4.3	V		
V _I	Input voltage	e			0 to V _{CC}	V		
V _{IC}	Control inpu	t voltage			0 to 4.3	V		
V _O	Output volta	ge			0 to V _{CC}	V		
T _{op}	Operating te	mperature	-55 to 125	°C				
d _t /d _v	Input rise and fall time control Inpu		ıt	$V_{CC} = 1.65V \text{ to } 2.7V$	0 to 20	ns/V		
u _t /u _v	input rise an	id lall time control inpo		$V_{CC} = 3.0 \text{ to } 4.3 \text{V}$	0 to 10	115/ V		
Table 4.	DC specif	ications		10,				
		Test conditions		Value				

^{1.} Truth Table guaranteed: 1.2V to 4.3V

DC Specifications 3.2

Table 4. **DC** specifications

		Test con	Value								
Symbol	ol Parameter	V _{CC} (V)		T _A = 25°C			-40 to 85°C		-55 to 125°C		Unit
				Min.	Тур	Max.	Тур	Max.	Тур	Max.	
		1.65-1.95		0.65 V _{CC}			0.65 V _{CC}		0.65 V _{CC}		
V _{IH}	/IH High level input voltage	2.3-2.5		1.4			1.4		1.4		V
		2.7-3.0		1.4			1.4		1.4		
		3.3 – 4.3		1.5			1.5		1.5		
× (C)		1.65-1.95				0.40		0.40		0.40	
V	V _{IL} Low level input voltage	2.3-2.5				0.50		0.50		0.50	60 V
VIL.		2.7-3.0		_		0.50		0.50	_	0.50	v
		3.3 – 4.3				0.50		0.50		0.50	

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Table 4. DC specifications

		Test con	ditions				Va	alue			
Symbol	Parameter	V _{CC} (V)		Т	A = 25	°C		0 to 5°C	-55 to	125°C	Unit
				Min.	Тур	Max.	Тур	Max.	Тур	Max.	
		4.3			0.5	0.7		1.4			
		3.0	V _S =0V		0.7	0.9		1.4			
R _{ON}	Switch ON	2.7	to V _{CC}		0.7	0.9		1.7			Ω
I ION	resistance	2.3	I _S =100 mA		0.9	1.2		1.7			22
		1.8	IIIA		1.3	1.6		1.9			
		1.65			1.60	2.5		2.2			
ΔR _{ON}	ON Resistance match between channels 1Sn and 2Sn	2.7	V _S @ R _{ON} Max I _S =100 mA		0.6				()(C	J'S	Ω
		4.3			0.18	0.21),		
	ON	3.0	$V_S = 0V$		0.16	0.19	O,				Ω
R _{FLAT}	resistance FLATNESS	2.7	to V _{CC}		0.16	0.19					
	(1) (2)	2.3	mA		0.18	0.21					
		1.65		C	0.38	0.44					
I _{OFF}	OFF state leakage current (nSN), (Dn)	4.3	V _S =0.3 or 4V	Ö,		±10		±100			nA
I _{IN}	Input leakage current	0-4.3	V _{IN} = 0 to 4.3V			±0.1		±1			μА
I _{CC}	Quiescent supply current	1.65–4.3	V _{IN} = V _{CC} or GND			±0.05		±0.2		±1	μΑ
loov	Quiescent supply current low	4.3	V _{1IN} , V _{2IN} = 1.65V		42	55					μА
I _{CCLV}	voltage driving	7.0	V _{1IN} , V _{2IN} = 1.80V		38	50					μΛ

^{1.} $\Delta RON = R_{ON(MAX)} - R_{ON(MIN)}$.

^{2.} Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

3.3 AC electrical characteristics

Table 5. AC electrical characteristics ($C_L = 35pF$, $R_L = 50\Omega$, $t_r = t_f \le 5ns$)

		Test co	nditions				Va	alue			
Symbol	Parameter			T,	_A = 25	°C	-40 to	85°C	-55 to	125°C	
		V _{CC} (V)		Min.	Тур.	Max.	Тур.	Max.	Тур.	Max.	Uni
		1.65-1.95			0.45						
t _{PLH} ,	Propagation	2.3-2.7			0.40						
t _{PHL}	delay	3.0-3.3			0.30						ns
		3.6-4.3			0.30						
		1.65-1.95	V _S = 0.8V		70						
	TURN-ON	2.3-2.7			30	60		75			
t _{ON}	time	3.0-3.3	V _S = 1.5V		25	50		60		16	ns
		3.6-4.3			25	50		60			١
		1.65-1.95	V _S = 0.8		45			2			
	TURN-OFF time	2.3-2.7			25	30		40			
t _{OFF}		3.0-3.3	$V_{S} = 1.5V$		25	30	0,	40			ns
		3.6-4.3			25	30		40			
	Break	1.65 – 1.95	C _L = 35pF	<u> </u>	7/6						
t_{D}	before make	2.3 – 2.7	$R_L = 50\Omega$	2	15						ns
	time delay	3.0 – 3.6	$V_{S} = 1.5V$	2	15						
		3.6 – 4.3		2	15						
		1.65-1.95	C _L =100pF		23						
Q	Charge	2.3 - 2.7	$R_L = 1M\Omega$		32						рC
	Injection	3.0 - 3.3	$V_{GEN} = 0V$		40						
te		3.6 - 4.3	$R_{GEN} = 0\Omega$		44						

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3.4 Analog switch characteristics

Table 6. Analog switch characteristics ($C_L = 5pF$, $R_L = 50\Omega$, $T_A = 25^{\circ}C$)

	Test Conditions		onditions				Va	alue			
Symbol	Parameter	er V _{CC} (V)		T,	T _A = 25°C		-40 to 85°C		-55 to 125°C		Unit
				Min.	Тур.	Max.	Тур.	Max.	Тур.	Max.	
OIRR	Off Isolation	1.65 - 4.3	$V_S=1V_{RMS}$ f = 100kHz		-90						dB
Xtalk	Crosstalk	1.6 - 4.3	$V_S=1V_{RMS}$ f = 100kHz		-76						dB
THD	Total harmonic distortion	3.0	$R_{L} = 600\Omega$ $V_{IN} = 2V_{PP}$ $f = 20Hz \text{ to}$ 20 kHz		0.03					19	%
BW	-3dB Bandwidth	1.65 - 4.3	$R_L = 50\Omega$		85			7	S		MHz
C _{IN}	Control pin input capacitance				7		P				pF
C _{Sn}	Sn port capacitance	3.3	f = 1MHz		35						pF
C _D	D port capacitance when switch is enabled	3.3	f = 1MHz	5	99						pF

^{1.} Off Isolation = $20Log_{10}$ (V_D/V_S), V_D = output, V_S = input at off switch.

3.5 Truth table

Table 7. Truth table

IN IN	Switch S1	Switch S2
Н	ON	OFF ⁽¹⁾
L	OFF ⁽¹⁾	ON

^{1.} High Impedance

STG3689 Application circuits

4 Application circuits

Figure 3. ON Resistance

Figure 4. OFF Isolation

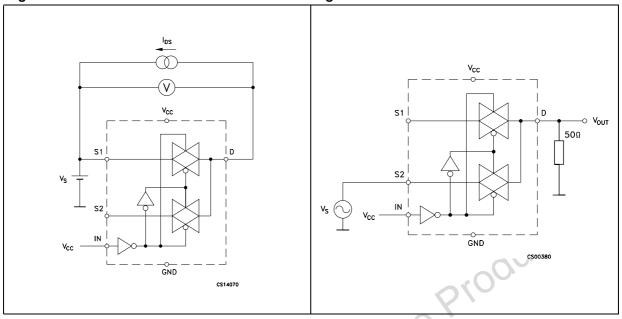
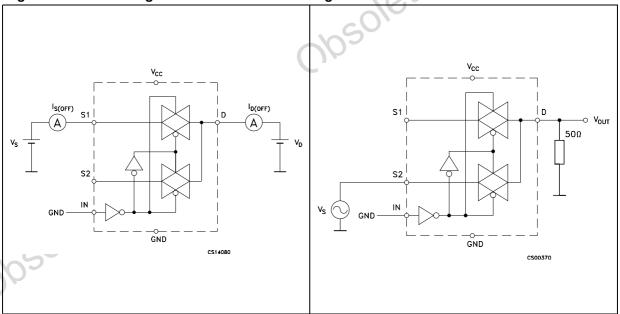


Figure 5. OFF Leakage

Figure 6. Bandwidth



Application circuits STG3689

Figure 7. Channel to channel crosstalk

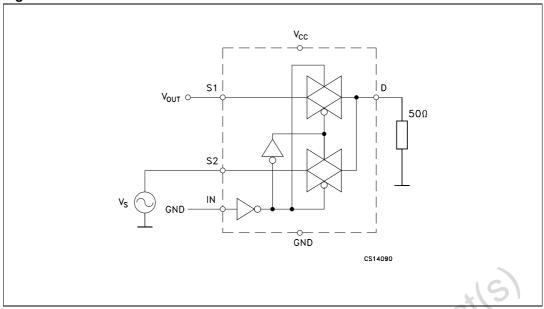
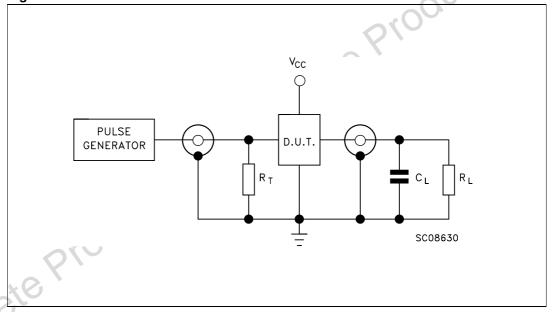


Figure 8. Test circuit



 $C_L = 5/35 pF$ or equivalent (includes jig and probe capacitance)

 $R_L = 50\Omega$ or equivalent

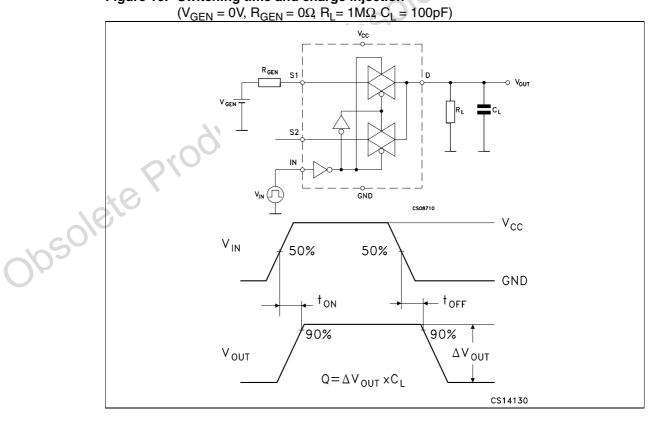
 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)

STG3689 Application circuits

 v_{cc} **S**1 ⊸ V_{out} V_S ○ S2 ⊸ GND CS14140 v_{cc} [′]50% 50% GND **←**†_D 90% 90% 90% 90% V_{OUT} ٥٧ CS14120

Figure 9. Break-before-make time delay

Figure 10. Switching time and charge injection



Application circuits STG3689

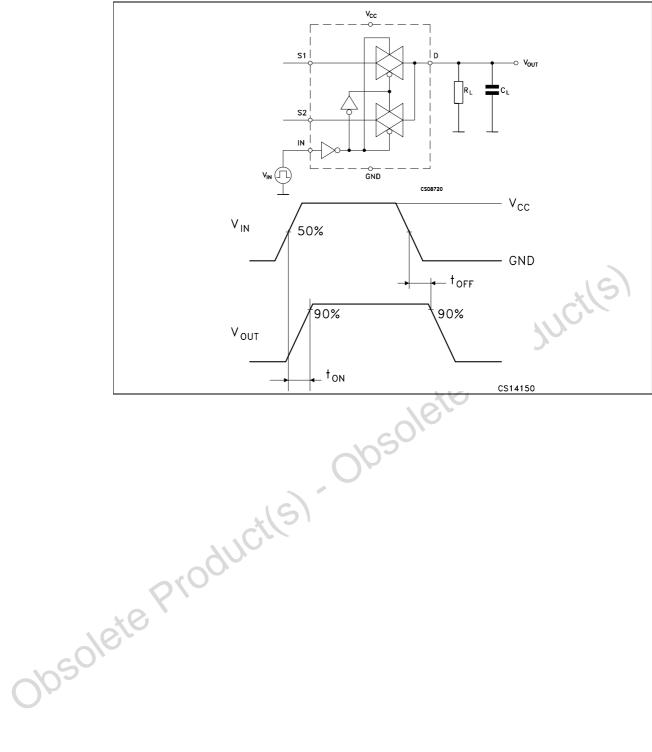


Figure 11. Turn ON, Turn OFF delay time

5 Package mechanical data

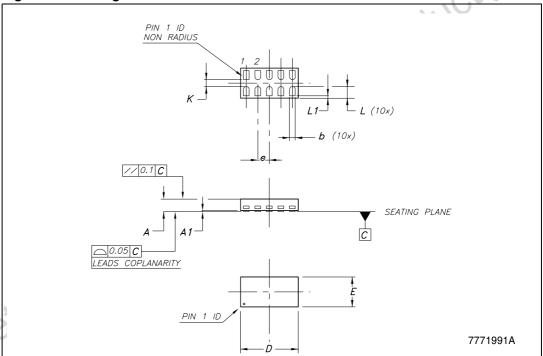
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Obsolete Product(s). Obsolete Product(s)

Table 8. DFN10L (2.5mm x 1.3mm) Mechanical data

Dim		mm.		inch			
Dim.	Min.	Тур.	Тур. Мах.		Тур.	Max.	
Α	0.50	0.55	0.60	19.7	21.7	23.6	
A1	0	0.02	0.05	0	0.8	2.0	
b	0.18	0.23	0.30	7.1	9.1	11.8	
D	2.40	2.50	2.60	94.5	98.4	102.4	
E	1.30	1.40	1.50	51.2	55.1	59.1	
е		0.50			19.7		
K	0.20			7.9			
L	0.45	0.50	0.55	17.7	19.7	21.6	
L1			0.15			5.9	

Figure 12. Package dimensions



STG3689 Revision history

6 Revision history

Table 9. Revision history

Date	Revision	Changes
23-Feb-2006	1	Initial release.
01-Aug-2006	2	Final version, small text changes for entire document.

Obsolete Product(s).

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